

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	BO-YI LIN	11/16/2020
RECEIVING PARTY DATA		
Name:	EDX EDUCATION CO., LTD.	
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City:	TAIPEI CITY	
State/Country:	TAIWAN	
Postal Code:	10681	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	29759119	
CORRESPONDENCE DATA		
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ATTORNEY DOCKET NUMBER:	D05841-F005	
NAME OF SUBMITTER:	CHING-YI LU	
SIGNATURE:	/Ching-Yi Lu/	
DATE SIGNED:	11/20/2020	
Total Attachments: 1		
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ASSIGNMENT

Title of Invention: **BUILDING BLOCK**

Whereas, the undersigned inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application;

Whereas, **EDX EDUCATION CO., LTD.**, having a place of business at **9F., No.39, Sec. 2, Dunhua S. Rd., Da-An Dist., Taipei City 10681, Taiwan (R.O.C.)** (herein referred to as "**EDX EDUCATION CO., LTD.**"), desires to acquire, and each undersigned inventor desires to grant to **EDX EDUCATION CO., LTD.**, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor ("ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to **EDX EDUCATION CO., LTD.** (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to **EDX EDUCATION CO., LTD.**, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by **EDX EDUCATION CO., LTD.**, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in **EDX EDUCATION CO., LTD.**, its successors, legal representatives, and assigns, whenever requested by **EDX EDUCATION CO., LTD.**, its successors, legal representatives, or assigns.

Each undersigned inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to **EDX EDUCATION CO., LTD.** and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned inventor also hereby grants **EDX EDUCATION CO., LTD.**, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1) Legal Name of Inventor: **LIN, BO-YI**

Signature: LIN, BO-YI Date: Nov, 16, 2020